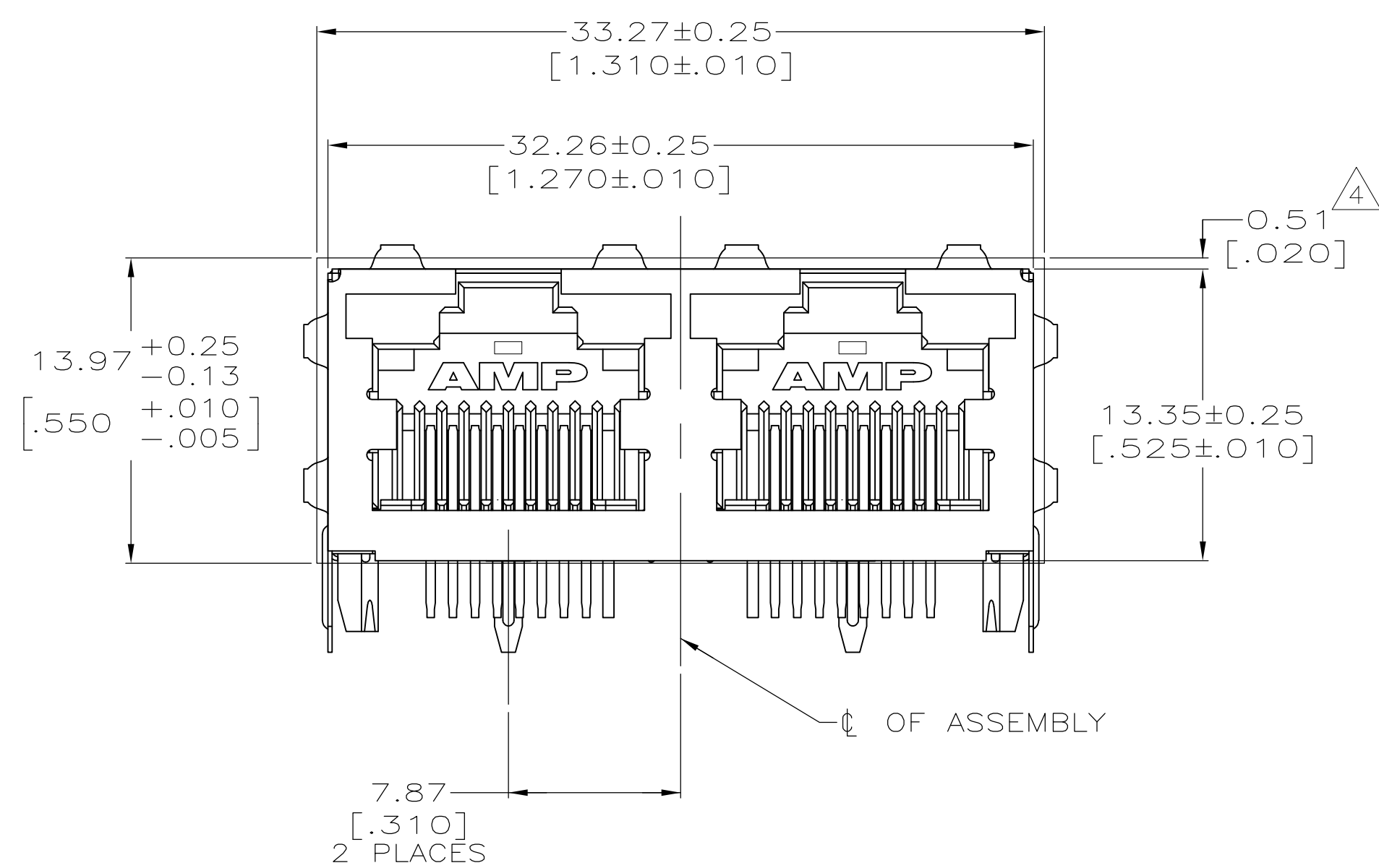




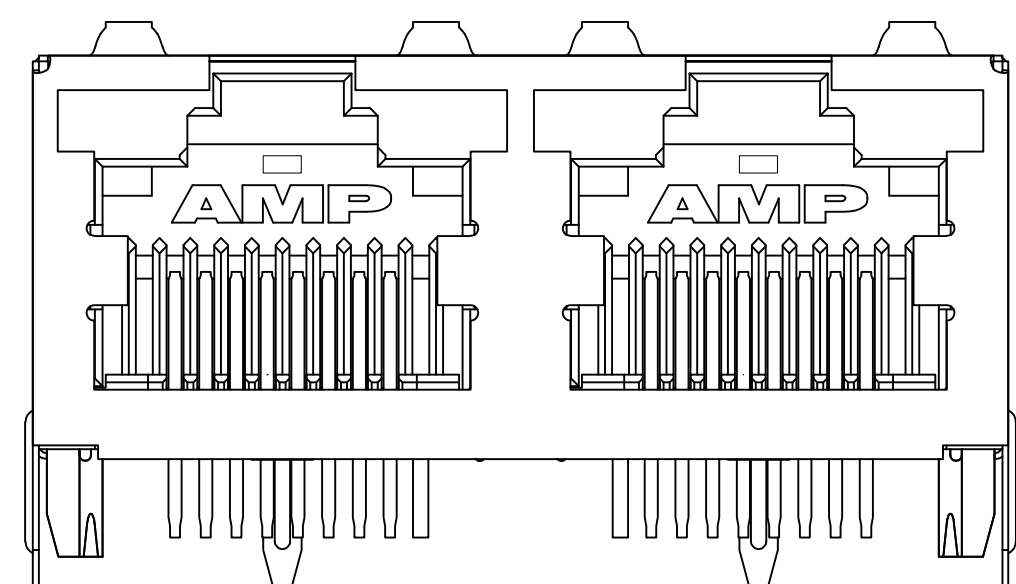
△ MATERIAL: HOUSING – HIGH TEMPERATURE
THERMOPLASTIC, BLACK, UL94V-0; IR REFLOW
SOLDERING PROCESS COMPATIBLE.
TERMINALS – 0.36[.014] THICK PHOS BRONZE
PLATED WITH 3.81µm[.000150] MINIMUM THICK
MATTE TIN IN SOLDER AREA. 1.27µm
[.000050] MINIMUM GOLD IN LOCALIZED PLATE
AREA. ENTIRE TERMINAL PLATED WITH 1.27µm
[.000050] MINIMUM THICK NICKEL.
SHIELD – 0.196[.0077] THICK COPPER ZINC ALLOY
PREPLATED WITH 1.27µm[.000050] MINIMUM SATIN
NICKEL WITH 2.03µm[.000080] MINIMUM TIN
POST DIPPED ON PCB GROUND TABS.

2. JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F.

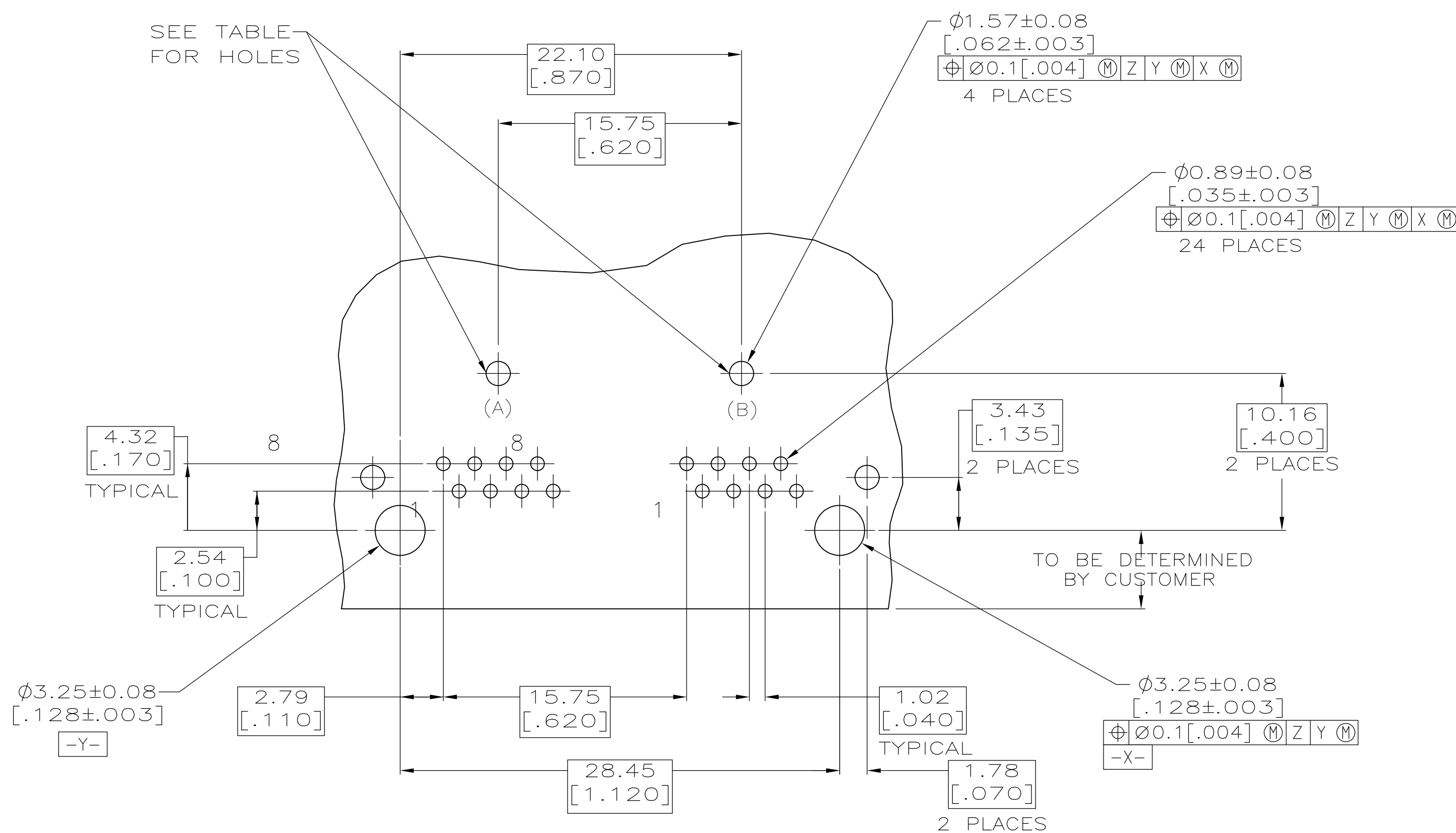
3 SUGGESTED PANEL OPENING DIMENSIONS.

△ SUGGESTED CLEARANCE BETWEEN TOP OF CONNECTOR AND TOP PANEL OPENING.

△5 TAPE&REEL PACKAGING WITH ANTISTANTIC.



PN: 6116522-3
SIMILAR TO 6116522-1, BUT WITHOUT EMI FINGERS ON BOTH SID



SUGGESTED PRINTED CIRCUIT BOARD LAYOUT
(COMPONENT SIDE)

2	4	TRAY	6116522-3
2	8	 T&R	6116522-2
2	8	TRAY	6116522-1
REAR TABS	EMI FINGERS	PACKAGE	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN 10JUN2005 CHG VARELA - DOCKS WESTMAN APR05 10JUN2005 S. FLICKINGER		 TE Connectivity	
DIMENSIONS: mm [INCHES]		TOLERANCES: UNLESS OTHERWISE SPECIFIED:		NAME INVERTED MODULAR JACK ASSEMBLY, 1X2, SHIELDED, PANEL GROUND	
		0 PLC ± - 1 PLC ± - 2 PLC ± 0.25[.01] 3 PLC ± 0.13[.005] 4 PLC ± - ANGLES ± - FINISH		PRODUCT SPEC 108-1163-4 APPLICATION SPEC 114-2154 WEIGHT - CUSTOMER DRAWING	
MATERIAL 				SIZE CAGE CODE DRAWING NO A1 00779 C-6116522 RESTRICTED TO -	
				SCALE 4:1 SHEET 1 of 1 REV A	